

ER SHEET

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Our Ref.: 1035-601

record the attached original documents or copy thereof.					
2. Name and address of receiving party(ies):					
Name: Sharp Kabushiki Kaisha Internal Address: 22-22 Nagaike-cho, Abeno-ku City: Osaka-shi, Osaka State/Country: Japan Zip: 545-8522 Additional name/s & address/es attached? Yes No					
s application is being filed together with a new application. B. Patent No(s). (1) (2) (3) tached Yes No 6. Total number of applications & patents involved: 7. Total fee (37 CFR 3.41) Enclosed Authorized to be charged to deposit account #14-1140 8. The Commissioner is hereby authorized to charge any deficiency in the fee(s) filed, or asserted to be filed, or which should have been filed herewith (or with any paper thereafter filed in this application by this firm) to our Account No. 14-1140.					
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09/20/2005 AADOF01 00000002 11227103 04 FC:8021

ASSIGNMENT OF U.S. PATENT APPLICATION					
	Yoshihisa DOTT	4			
(Inventors)					
	In conside	ration of the sum of one dol	lar (\$1.00) and other go	od and valuable	
	considerations pai	d to each of the undersigned	d, the undersigned agree	e(s) to assign, and	
(Assignee)	hereby does assig SHARP KABUSHI	n, transfer and set over to KAISHA	a corporation of	Osaka, Japan	
(Address)	22-22, Nagaike-ch	o Abeno-ku Osaka-shi Osa	ka 545-8522 Japan		
	(hereinafter designated as the Assignee) the undersigned's entire right, title and interest for the United States, its territories, dependencies and possessions in the invention, and all				
	applications for patent and any Letters Patent which may be granted therefore, known as				
(Title)	SEMICONDUCTO	OR DEVICE AND FABRICA	TION METHOD THERE	EOF	
	for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed on Sep. 1, 2005 or has already filed U.S. application Serial No, on				
	The undersigned acknowledges an obligation of assignment of this invention to said assignee at the time the invention was made.				
application or and also to ed deem necess	r any interference w xecute separate ass sary or expedient an	s) to execute all papers and hich may be declared and a signments in connection with d further to perform any act ational Convention for Prote	ny continuing or division n such applications as th which may be necessar	al applications thereof ne Assignee may ry in connection with	
The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.					
The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.					
The undersigned hereby grant(s) the firm of NIXON & VANDERHYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhye P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.					
In wit signature(s).	tness whereof, exec	cuted by the undersigned on	the date(s) opposite the	e undersigned	
DateS	iep.1.2005	Signature of inventor	Yoshikisa D)otta	
Date		Signature of inventor			
Date		Signature of inventor			
Date		Signature of inventor			
Date		Signature of inventor			
Witnessed by	/:	**************************************	Date		
Witnessed by	<i>r</i> :		Date		
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PATENT REEL: 017002 FRAME: 0992

Case No. : _____